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Please find below and/or attached an Office communication concerning this application or proceeding.

If NO period for reply is specified above, the maximum statutory period will apply and will expire 6 MONTHS from the mailing date of this communication.

i vi		Applicatio	n No.	Applicant(s)
Office Action Summary		10/712,06	2	YAMAZAKI ET AL.
		Examiner		Art Unit
	·	Benjamin 1	. Liu	2826
Period fo	The MAILING DATE of this communication ap	ppears on the	cover sheet with the	correspondence address
A SH WHIC - Exter after - If NC - Failu Any	ORTENED STATUTORY PERIOD FOR REPLEMENTS LONGER, FROM THE MAILING Insions of time may be available under the provisions of 37 CFR 1 SIX (6) MONTHS from the mailing date of this communication. Operiod for reply is specified above, the maximum statutory period re to reply within the set or extended period for reply will, by statureply received by the Office later than three months after the mailing datent term adjustment. See 37 CFR 1.704(b).	DATE OF TH I.136(a). In no eve d will apply and will ute, cause the appli	IS COMMUNICATIO nt, however, may a reply be to expire SIX (6) MONTHS fror cation to become ABANDON	N. imely filed on the mailing date of this communication. ED (35 U.S.C. § 133).
Status				
•	Responsive to communication(s) filed on 16 on 1	nis action is no rance except t	on-final. for formal matters, pr	
Disposit	ion of Claims			
5)□ 6)⊠ 7)□ 8)□ <b>Applicat</b> 9)□ 10)□	Claim(s) 1-18 is/are pending in the application 4a) Of the above claim(s) is/are withdred claim(s) is/are allowed.  Claim(s) 1-18 is/are rejected.  Claim(s) is/are objected to.  Claim(s) are subject to restriction and/or in the specification is objected to by the Examination The drawing(s) filed on is/are: a) and Applicant may not request that any objection to the Replacement drawing sheet(s) including the correct The oath or declaration is objected to by the Examination of the correct the oath or declaration is objected to by the Examination of the oath or declaration is objected to by the Examination of the oath or declaration is objected to by the Examination of the oath or declaration is objected to by the Examination of the oath or declaration is objected to by the Examination of the oath or declaration is objected to by the Examination of the oath or declaration is objected to by the Examination of the oath or declaration is objected to by the Examination of the oath or declaration is objected to by the Examination of the oath or declaration is objected to by the Examination of the oath or declaration is objected to by the Examination of the oath or declaration is objected to by the Examination of the oath or declaration is objected to by the Examination of the oath or declaration is objected to by the Examination of the oath or declaration is objected to by the Examination of the oath or declaration of the oath or declaration is objected to by the Examination of the oath or declaration is objected to by the Examination of the oath or declaration is objected to by the Examination of the oath of the oath or declaration is objected to by the Examination of the oath of the oa	awn from con /or election re- ner. ccepted or b)[ ne drawing(s) be- ection is require	equirement.  objected to by the e held in abeyance. Seed if the drawing(s) is o	ee 37 CFR 1.85(a). bjected to. See 37 CFR 1.121(d).
Priority i	under 35 U.S.C. § 119			
12)⊠ a)	Acknowledgment is made of a claim for foreig  All b) Some * c) None of:  1. Certified copies of the priority document  2. Certified copies of the priority document  3. Copies of the certified copies of the priority application from the International Bure  See the attached detailed Office action for a list	nts have beer nts have beer iority docume au (PCT Rule	n received. n received in Applica nts have been receive 17.2(a)).	tion No ved in this National Stage
2) Notice 3) Information	nt(s)  ce of References Cited (PTO-892)  ce of Draftsperson's Patent Drawing Review (PTO-948)  mation Disclosure Statement(s) (PTO/SB/08)  er No(s)/Mail Date 10/23/06		4) Interview Summar Paper No(s)/Mail I 5) Notice of Informal 6) Other:	Date

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## **DETAILED ACTION**

## Claim Rejections - 35 USC § 103

- 1. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 1 and 3-6 are rejected under 35 U.S.C 103(a) as being unpatentable over Miyawaki (5,717,473).

With regard to claim 1, figures 8A-8J of Miyawaki disclose a semiconductor device comprising: a channel region 3001 provided over a substrate 3 and between a source region and a drain region 1610; a gate electrode 1607 provided over the substrate 3 and provided adjacent to the channel region 3001 with a gate insulating film 1601 between the gate electrode 1607 and the channel region 3001; a first insulating film 1611 comprising silicon nitride ("SiN") provided over the channel region 3001 and the source region and the drain region 1610 and the gate electrode 1607 and the gate insulating film 1601; a second insulating film 1612 provided over the first insulating film 1611; a drain electrode 1613 connected with the drain region 1610 and provided over the second insulating film 1612; a source electrode 1613 connected with the source region 1610 and provided over the second insulating film 1612 a third insulating film provided 1616 over the drain electrode 1613 and the source electrode 1613 to provide a leveled surface ("flatten") over the drain electrode 1613 and the source electrode electrode 1613;

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a black matrix 1617 provided over the third insulating film 1616; a fourth insulating film 1618 provided over the black matrix 1617 to provide a third leveled surface ("flatten") over the black matrix 1617; and a pixel electrode 1619 connected with one of the drain electrode 1613 and the source electrode 1613 and provided over the fourth insulating film 1618.

Figures 8A-8J of Miyawaki does not disclose the first insulating film and comprising resin to provide a first leveled surface over said first insulating film, a third insulating film comprising resin, a fourth insulating film comprising resin.

However, figure 12 of Miyawaki discloses the insulating film 1915 comprising a resin ("resin"). Miyawaki also discloses an insulating layer deposited to flatten an etch back and the like. (Note line 35 col 6)

Therefore, it would have been obvious to one of ordinary skill in the art to form the device of figure 8A-8J of Miyawaki with the limitation of figure 12 of Miyawaki in order to stick two layers together. (Note lines 7-8 col 14 of Miyawaki)

With regard to claim 3, figures 8A-8J of Miyawaki disclose the limitation, wherein the semiconductor film has a thickness of 100 to 750 A ("100 to 700A"). (Note line 23 col 9)

With regard to claim 4, figures 8A-8J of Miyawaki disclose the limitation, wherein the semiconductor device is incorporated into one selected from the group consisting of a portable intelligent terminal, a head mounted display, a car navigational system, a mobile telephone, a portable video camera, and a projection display ("projection TV). (Note line 5 col 3)

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With regard to claim 5, figures 8A-8J of Miyawaki disclose the limitation, wherein the semiconductor device is incorporated into a liquid crystal display. (Note title)

With regard to claim 6, figures 8A-8J of Miyawaki disclose the limitation, wherein the semiconductor device is incorporated into an electroluminescent display. (Note abstract)

Claim 2 is rejected under 35 U.S.C 103(a) as being unpatentable over Miyawaki (5,717,473) in view of Funai et al. (5,550,070).

With regard to claim 2, Miyawaki discloses all the subject matter claimed except for the limitation, wherein the channel region and the source region and the drain region are provided in a semiconductor film comprising a plurality of radial crystal grains of silicon.

However, figures 1-16 of Funai et al. disclose the limitation, wherein the channel region 118 and the source region 116 and the drain region 117 are provided in a semiconductor film 112 comprising a plurality of radial crystal grains of silicon 107.

Therefore, it would have been obvious to one of ordinary skill in the art to form the device of Miyawaki with the limitation of Funai et al. in order to control the crystal growth direction by selectively introducing the catalytic element. (Note lines 40-43 col 6 Funai et al.)

Claims 7, 9-13, and 15-18 are rejected under 35 U.S.C 103(a) as being unpatentable over Miyawaki (5,717,473) in view of Matsuo et al. (5,414,547).

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With regard to claim 7, figures 8A-8J of Miyawaki disclose a semiconductor device comprising: a channel region 3001 provided over a substrate 3 and between a source region and a drain region 1610; a gate electrode 1607 provided over the substrate 3 and provided adjacent to the channel region 3001 with a gate insulating film 1601 between the gate electrode 1607 and the channel region 3001; a first insulating film 1611 comprising silicon nitride ("SiN") provided over the channel region 3001 and the source region and the drain region 1610 and the gate electrode 1607 and the gate insulating film 1601; a second insulating film 1612 provided over the first insulating film 1611; a drain electrode 1613 connected with the drain region 1610 and provided over the second insulating film 1612; a source electrode 1613 connected with the source region 1610 and provided over the second insulating film 1612 a third insulating film provided 1616 over the drain electrode 1613 and the source electrode 1613 to provide a leveled surface ("flatten") over the drain electrode 1613 and the source electrode 1613; a black matrix 1617 provided over the third insulating film 1616; a fourth insulating film 1618 provided over the black matrix 1617 to provide a third leveled surface ("flatten") over the black matrix 1617; and a pixel electrode 1619 connected with one of the drain electrode 1613 and the source electrode 1613 and provided over the fourth insulating film 1618.

Figures 8A-8J of Miyawaki does not disclose the first insulating film and comprising polyimide to provide a first leveled surface over said first insulating film, a third insulating film comprising polyimide, a fourth insulating film comprising polyimide.

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However, figure 9 of Matsuo et al. discloses the insulating film 215 comprising a polyimide ("polyimide") to provide a leveled ("flatten") surface over the insulating film 215. (Note lines 1-15 col 21)

Therefore, it would have been obvious to one of ordinary skill in the art to form the device of figure 8A-8J of Miyawaki with the limitation of figure 9 of Matsuo in order to flatten the surface of the insulating film for the purpose of further improving the orienting characteristics of the liquid crystal. (Note lines 10-17 col 21 of Matsuo)

With regard to claim 9, figures 8A-8J of Miyawaki disclose the limitation, wherein the semiconductor film has a thickness of 100 to 750 A ("100 to 700A"). (Note line 23 col 9)

With regard to claim 10, figures 8A-8J of Miyawaki disclose the limitation, wherein the semiconductor device is incorporated into one selected from the group consisting of a portable intelligent terminal, a head mounted display, a car navigational system, a mobile telephone, a portable video camera, and a projection display ("projection TV). (Note line 5 col 3)

With regard to claim 11, figures 8A-8J of Miyawaki disclose the limitation, wherein the semiconductor device is incorporated into a liquid crystal display. (Note title)

With regard to claim 12, figures 8A-8J of Miyawaki disclose the limitation, wherein the semiconductor device is incorporated into an electroluminescent display. (Note abstract)

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With regard to claim 13, figures 8A-8J of Miyawaki disclose a semiconductor device comprising: a channel region 3001 provided over a substrate 3 and between a source region and a drain region 1610; a gate electrode 1607 provided over the substrate 3 and provided adjacent to the channel region 3001 with a gate insulating film 1601 between the gate electrode 1607 and the channel region 3001; a first insulating film 1611 comprising silicon nitride ("SiN") provided over the channel region 3001 and the source region and the drain region 1610 and the gate electrode 1607 and the gate insulating film 1601; a second insulating film 1612 provided over the first insulating film 1611; a drain electrode 1613 connected with the drain region 1610 and provided over the second insulating film 1612; a source electrode 1613 connected with the source region 1610 and provided over the second insulating film 1612 a third insulating film provided 1616 over the drain electrode 1613 and the source electrode 1613 to provide a leveled surface ("flatten") over the drain electrode 1613 and the source electrode 1613; a black matrix 1617 provided over the third insulating film 1616; a fourth insulating film 1618 provided over the black matrix 1617 to provide a third leveled surface ("flatten") over the black matrix 1617; and a pixel electrode 1619 connected with one of the drain electrode 1613 and the source electrode 1613 and provided over the fourth insulating film 1618.

Figures 8A-8J of Miyawaki does not disclose the first insulating film and comprising resin to provide a first leveled surface over said first insulating film, a third insulating film comprising resin, a fourth insulating film comprising resin.

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However, figure 12 of Miyawaki discloses the insulating film 1915 comprising a resin ("resin"). Miyawaki also discloses an insulating layer deposited to flatten an etch back and the like. (Note line 35 col 6)

Therefore, it would have been obvious to one of ordinary skill in the art to form the device of figure 8A-8J of Miyawaki with the limitation of figure 12 of Miyawaki in order to stick two layers together. (Note lines 7-8 col 14 of Miyawaki)

Miyawaki does not discloses the limitation, wherein at least a part of the black matrix is in contact with at least a part of the one of the drain electrode and the source electrode.

However, figure 9 of Matsuo discloses the limitation, wherein at least a part of the black matrix 216ba is in contact (electrically connected to pixel electrode 206 which is electrically connected to drain 207) with at least a part of the one of the drain electrode 207 and the source electrode. (Note abstract)

Therefore, it would have been obvious to one of ordinary skill in the art to form the device of Miyawaki with the limitation of Matsuo in order to obtain excellent display qualities by applying the same potential to the pixel electrode and black matrix and not disorientating the state of the liquid crystal. (Note lines 7-15 col 13 Matsuo et al.)

With regard to claim 15, figures 8A-8J of Miyawaki disclose the limitation, wherein the semiconductor film has a thickness of 100 to 750 A ("100 to 700A"). (Note line 23 col 9)

With regard to claim 16, figures 8A-8J of Miyawaki disclose the limitation, wherein the semiconductor device is incorporated into one selected from the group

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consisting of a portable intelligent terminal, a head mounted display, a car navigational system, a mobile telephone, a portable video camera, and a projection display ("projection TV). (Note line 5 col 3)

With regard to claim 17, figures 8A-8J of Miyawaki disclose the limitation, wherein the semiconductor device is incorporated into a liquid crystal display. (Note title)

With regard to claim 18, figures 8A-8J of Miyawaki disclose the limitation, wherein the semiconductor device is incorporated into an electroluminescent display. (Note abstract)

Claims 8 and 14 are rejected under 35 U.S.C 103(a) as being unpatentable over Miyawaki (5,717,473) in view of Matsuo et al. (5,414,547) and further in view of Funai et al. (5,550,070).

With regard to claims 8 and 14, Miyawaki and Matsuo et al. discloses all the subject matter claimed except for the limitation, wherein the channel region and the source region and the drain region are provided in a semiconductor film comprising a plurality of radial crystal grains of silicon.

However, figures 1-16 of Funai et al. disclose the limitation, wherein the channel region 118 and the source region 116 and the drain region 117 are provided in a semiconductor film 112 comprising a plurality of radial crystal grains of silicon 107.

Therefore, it would have been obvious to one of ordinary skill in the art to form the device of Miyawaki and Matsuo et al. with the limitation of Funai et al. in order to

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control the crystal growth direction by selectively introducing the catalytic element.

(Note lines 40-43 col 6 Funai et al.)

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2. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Benjamin T. Liu whose telephone number is (571) 272-6009. The examiner can normally be reached on Mon-Fri 9:30 AM-6:00PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Sue A. Purvis can be reached on 571 272 1236. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

BTL 4/9/2007